

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Young Won KIM</td> <td>12/22/2010</td> </tr> <tr> <td>Jun Ho LEE</td> <td>12/22/2010</td> </tr> <tr> <td>Hyun Seok KIM</td> <td>12/22/2010</td> </tr> <tr> <td>Boo Ho JUNG</td> <td>12/22/2010</td> </tr> <tr> <td>Sun Ki CHO</td> <td>12/22/2010</td> </tr> <tr> <td>Yang Hee KIM</td> <td>12/22/2010</td> </tr> </tbody> </table>		Name	Execution Date	Young Won KIM	12/22/2010	Jun Ho LEE	12/22/2010	Hyun Seok KIM	12/22/2010	Boo Ho JUNG	12/22/2010	Sun Ki CHO	12/22/2010	Yang Hee KIM	12/22/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Hynix Semiconductor Inc.</td> </tr> <tr> <td>Street Address:</td> <td>San 136-1, Ami-ri, Bubal-eup</td> </tr> <tr> <td>City:</td> <td>Icheon-si Gyeonggi-do</td> </tr> <tr> <td>State/Country:</td> <td>REPUBLIC OF KOREA</td> </tr> </table>		Name:	Hynix Semiconductor Inc.	Street Address:	San 136-1, Ami-ri, Bubal-eup	City:	Icheon-si Gyeonggi-do	State/Country:	REPUBLIC OF KOREA						
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PROPERTY NUMBERS Total: 1															
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12983211</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12983211										
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CORRESPONDENCE DATA															
<p>Fax Number: (630)908-7653</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 630 908 7652</p> <p>Email: uspto.actions@wwplaw.com</p> <p>Correspondent Name: William Park & Associates LTD.</p> <p>Address Line 1: 930 N. York Road, Suite 201</p> <p>Address Line 4: Hinsdale, ILLINOIS 60521</p>															
ATTORNEY DOCKET NUMBER:	PA0208-0														
NAME OF SUBMITTER:	Woochoon W. Park														

OP \$40.00 12983211

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PATENT
REEL: 025570 FRAME: 0537

Total Attachments: 3

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PATENT

REEL: 025570 FRAME: 0538

DOCKET:

PATENT

ASSIGNMENT OF APPLICATION

Now, therefore, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the assignor(s)

ASSIGNOR(S)

KIM, Young Won
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

LEE, Jun Ho
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

KIM, Hyun Seok
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

JUNG, Boo Ho
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

CHO, Sun Ki
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

KIM, Yang Hee
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

by these presents do sell, assign and transfer unto said assignee

ASSINGEE

Hynix Semiconductor Inc.
San 136-1, Ami-ri, Bubal-eub, Ichon-si, Gyeonggi-do 467-860, Republic of Korea

and the heirs, successors, assigns and legal representatives of the assignee the full and exclusive right to the said invention in the United States which are disclosed in the U.S. patent application titled

A MULTI-CHIP PACKAGE WITH IMPROVED SIGNAL TRANSMISSION

☐ for which an application for a United States Patent was filed on _____
Application Number _____; or

☐ for which an application for a United States Patent was executed by the undersigned on _____

DOCKET:

PATENT


and any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

The assignor(s) agree promptly upon request of the Assignee, its heirs, successors, assigns and legal representatives of the assignee to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney, Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary or fully


Assignor(s) hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

Assignor(s) further covenants that assignee will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to Assignor(s) and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to assignee or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

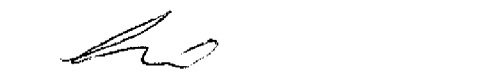
ASSIGNOR SIGNATURE(S)


KIM, Young Won

2010. 12. 22
Date


LEE, Jun Ho

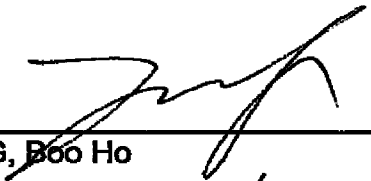
2010. 12. 22
Date


KIM, Hyun Seok

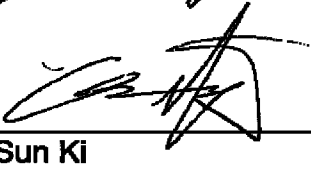
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JUNG, Boo Ho

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Date


CHO, Sun Ki

20/0. 12-22
Date


KIM, Yang Hee

20/0. 12-22
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